



Material Content Data Sheet				RoHS		Halogen-Free		
Sales Product Name	BTS5008-1EKB MA001259238			Issued		25. January 2018		
MA#								
Package	PG-DSO-14-47			Weight*		151.05 mg		
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	4.820	3.19	3.19	31912	31912
leadframe	inorganic material	phosphorus	7723-14-0	0.017	0.01		114	
	non noble metal	zinc	7440-66-6	0.069	0.05		458	
	non noble metal	iron	7439-89-6	1.383	0.92		9159	
	non noble metal	copper	7440-50-8	56.175	37.19	38.17	371902	381633
wire	non noble metal	copper	7440-50-8	0.787	0.52	0.52	5210	5210
encapsulation	organic material	carbon black	1333-86-4	0.165	0.11		1093	
	plastics	epoxy resin	-	7.593	5.03		50269	
	inorganic material	silicondioxide	60676-86-0	74.775	49.50	54.64	495041	546403
leadfinish	non noble metal	tin	7440-31-5	2.472	1.64	1.64	16364	16364
plating	noble metal	silver	7440-22-4	1.470	0.97	0.97	9734	9734
glue	plastics	epoxy resin	-	0.231	0.15		1530	
	noble metal	silver	7440-22-4	1.090	0.72	0.87	7214	8744
*deviation	< 10%				Sum in total:	100.00		1000000

## Important Remarks:

- 1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
- 2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
- 3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and does not use any exemption

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